

650V Super Junction Power MOSFET

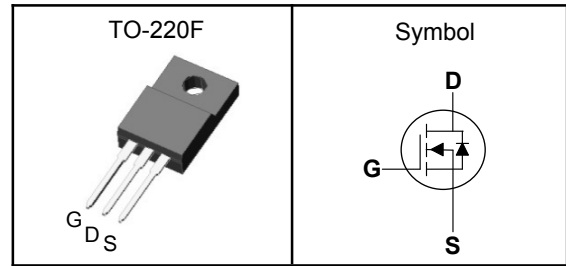
Features

- Low drain-source on-resistance: $R_{DS(ON)}=0.12\Omega(\text{typ})$
- Easy to control gate switching
- Enhancement mode: $V_{th} = 2.5$ to $4.5V$
- 100% avalanche tested
- RoHS compliant

Applications

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)
- Charger, Lighting

Pin Description



V_{DSS}	650	V
$R_{DS(ON)-Typ}$	120	m Ω
I_D	24	A

Absolute Maximum Ratings ($T_C=25^\circ C$, Unless Otherwise Noted)

Symbol	Parameter	Rating	Unit
V_{DSS}	Drain-Source Voltage	650	V
V_{GSS}	Gate-Source Voltage	± 30	V
T_J	Maximum Junction Temperature	-55 to 150	$^\circ C$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
E_{AS}	Single Pulse Avalanche Energy ³	455	mJ
$I_{DM}^{①}$	300 μs Pulse Drain Current Tested	72	A
I_D	Continuous Drain Current	24	A
P_D	Maximum Power Dissipation	44	W
I_{AS}	Avalanche Current	3.9	A
dv/dt	MOSFET dv/dt ruggedness, $V_{DS} = 0 \dots 400V$	50	V/ns
	Reverse diode dv/dt ³ $V_{DS}=0 \dots 400V, I_{SD} \leq I_D$	100	

Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JA}^{③}$	Thermal Resistance Junction-Ambient ¹ (Max)	62	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction-Case ¹ (Max)	2.85	$^\circ C/W$

Note ① : Max. current is limited by bonding wire.

Note ② : UIS tested and pulse width are limited by maximum junction temperature $150^\circ C$.

Note ③ : Surface Mounted on $1in^2$ FR-4 board with 1oz.



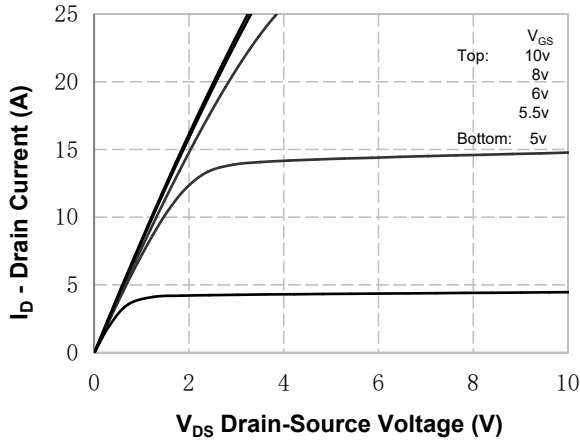
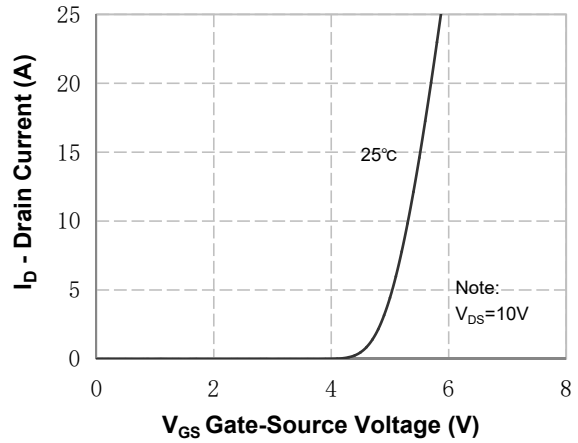
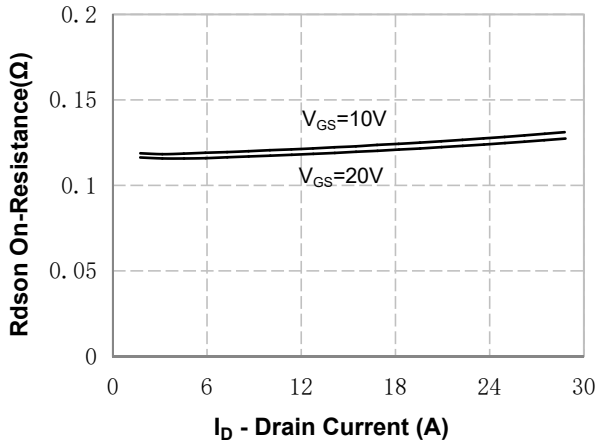
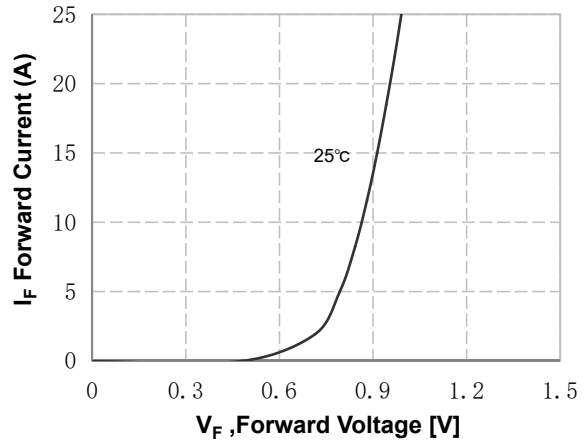
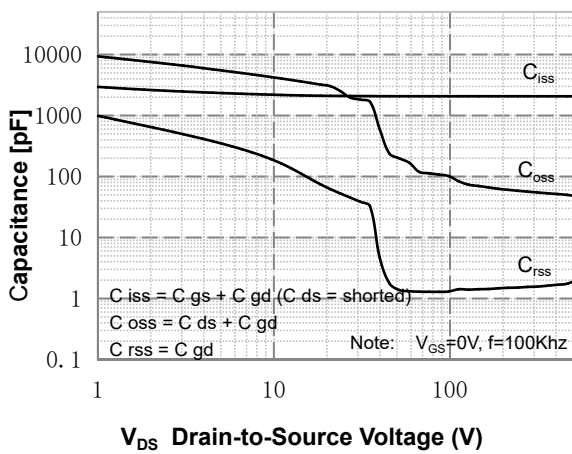
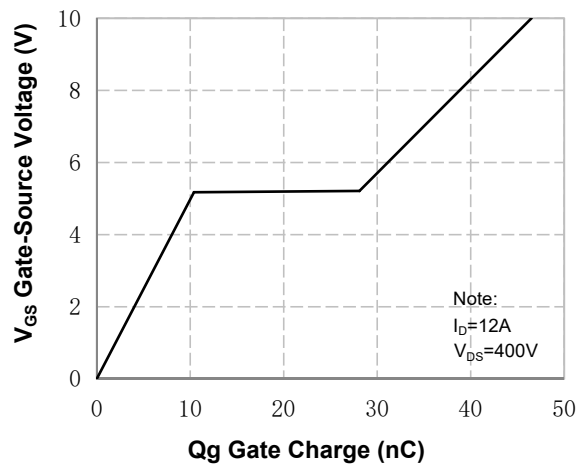
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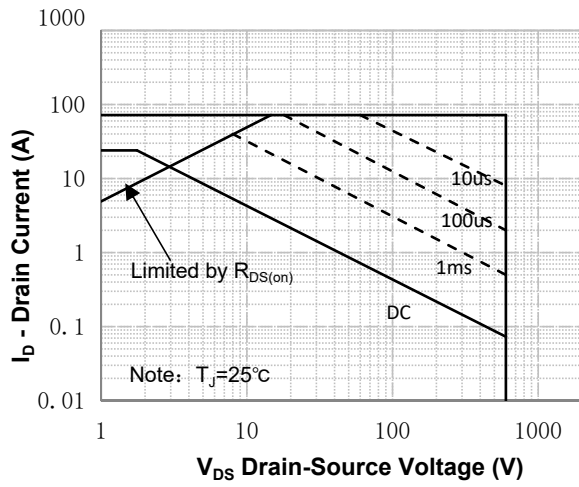
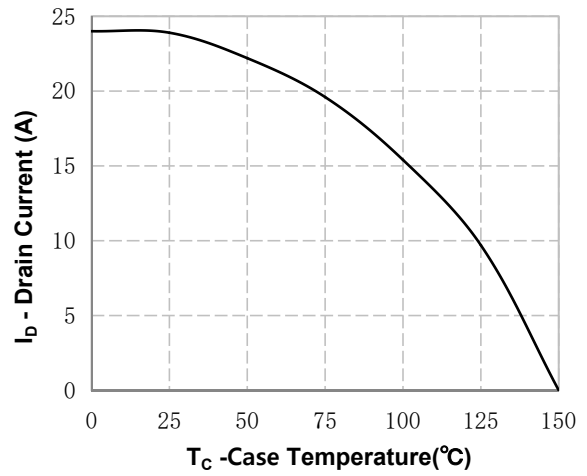
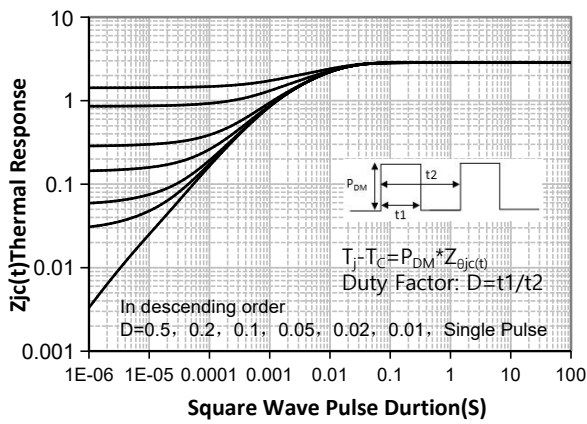
Electrical Characteristics ($T_J=25^{\circ}\text{C}$, Unless Otherwise Noted)

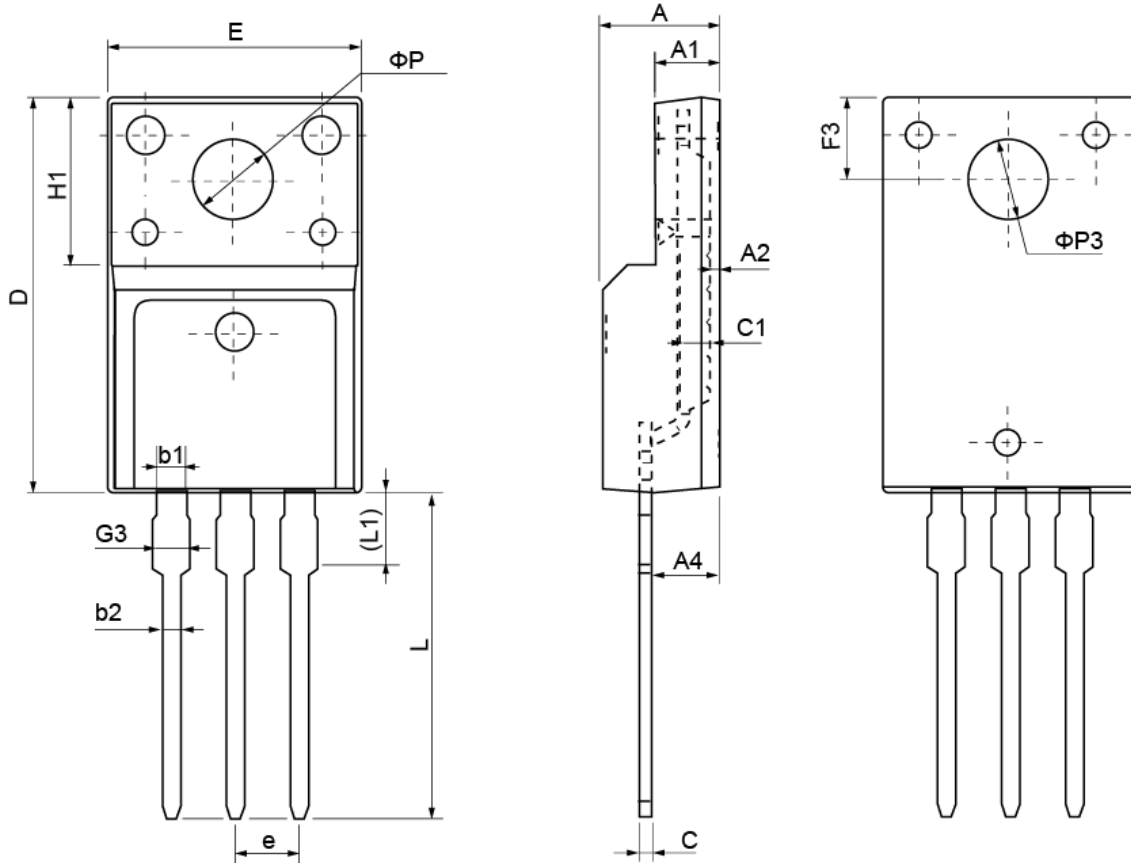
Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	650	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=600V, V_{GS}=0V$	---	---	10	μA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2.5	---	4.5	V
I_{GSS}	Gate Leakage Current	$V_{GS}=\pm 30V, V_{DS}=0V$	---	---	± 100	nA
$R_{DS(ON)}$	Drain-Source On-state Resistance	$V_{GS}=10V, I_D=12A$	---	120	135	m Ω
Dynamic Characteristics ^⑤						
C_{iss}	Input Capacitance	$V_{GS}=0V,$ $V_{DS}=100V,$ Freq.=1MHz	---	2072	---	pF
C_{oss}	Output Capacitance		---	101	---	
C_{rss}	Reverse Transfer Capacitance		---	1.3	---	
$T_{d(on)}$	Turn-on Delay Time	$V_{DD}=400V, V_{GS}=10V,$ $R_G=4.7\Omega, I_D=12A$	---	21	---	nS
T_r	Turn-on Rise Time		---	40	---	
$T_{d(off)}$	Turn-off Delay Time		---	56	---	
T_f	Turn-off Fall Time		---	14	---	
R_g	Gate Resistance	$f = 1.0\text{MHz}, \text{open drain}$	---	1.9	---	Ω
Q_g	Total Gate Charge	$V_{DS}=400V, V_{GS}=10V,$ $I_D=12A$	---	46	---	nC
Q_{gs}	Gate-Source Charge		---	8	---	
Q_{gd}	Gate-Drain Charge		---	15	---	
Source-Drain Characteristics ($T_J=25^{\circ}\text{C}$)						
V_{SD} ^④	Diode Forward Voltage	$I_S=12A, V_{GS}=0V$	---	---	1.4	V
t_{rr}	Reverse Recovery Time	$V_R=400V, I_F=12A,$ $di/dt=130A/\mu s, T_J=25^{\circ}\text{C}$	---	110	---	nS
Q_{rr}	Reverse Recovery Charge		---	0.8	---	nC

Note ④ : Pulse test (pulse width \leq 300us, duty cycle \leq 2%).

Note ⑤ : Guaranteed by design, not subject to production testing.

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Typical Characteristics

Figure 1. On-Region Characteristics

Figure 2. Transfer Characteristics

Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

Figure 4. Body Diode Forward Voltage Variation with Source Current

Figure 5. Capacitance Characteristics

Figure 6. Gate Charge Characteristics

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Figure 7. Maximum Safe Operating Area

Figure 8. Maximum Drain Current vs Case Temperature

Figure 9. Transient Thermal Response Curve

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TO-220F Package Outline Dimensions


Symbol	Dimensions (unit:mm)			Symbol	Dimensions (unit:mm)		
	Min	Typ	Max		Min	Typ	Max
A	4.40	4.70	5.00	H1	6.70 REF		
A1	2.30	2.55	2.80	L	12.30	12.98	13.30
A2	0.30	0.50	0.70	L1	2.95	3.10	3.50
A4	2.45	2.80	3.05	ϕP	3.03	3.20	3.50
c	0.30	0.50	0.70	$\phi P3$	3.15	3.45	3.65
c1	1.20	1.30	1.40	b1	1.10	1.30	1.45
D	15.40	15.90	16.40	b2	0.60	0.80	1.00
E	9.86	10.16	10.46	F3	3.05	3.30	3.55
e	2.54 BSC			G3	1.15	1.35	1.55